

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chi-Sheng Chen</td> <td>02/25/2013</td> </tr> <tr> <td>Shin-Chi Chen</td> <td>02/25/2013</td> </tr> <tr> <td>Chih-Yueh Li</td> <td>02/25/2013</td> </tr> <tr> <td>Ted Ming-Lang Guo</td> <td>11/26/2012</td> </tr> <tr> <td>Bo-Syuan Lee</td> <td>11/26/2012</td> </tr> <tr> <td>Tsung-Hsun Tsai</td> <td>02/25/2013</td> </tr> <tr> <td>Yu-Chin Cheng</td> <td>12/27/2012</td> </tr> </tbody> </table>		Name	Execution Date	Chi-Sheng Chen	02/25/2013	Shin-Chi Chen	02/25/2013	Chih-Yueh Li	02/25/2013	Ted Ming-Lang Guo	11/26/2012	Bo-Syuan Lee	11/26/2012	Tsung-Hsun Tsai	02/25/2013	Yu-Chin Cheng	12/27/2012
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<table border="1"> <tr> <td>Name:</td> <td>UNITED MICROELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>No.3, Li-Hsin Road 2, Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsin-Chu City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	UNITED MICROELECTRONICS CORP.	Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	City:	Hsin-Chu City	State/Country:	TAIWAN								
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CORRESPONDENCE DATA																	
Fax Number: 7039974517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116																	
ATTORNEY DOCKET NUMBER:	NAUP1570USA																
NAME OF SUBMITTER:	SIBYL YU																

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**Total Attachments: 14**

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**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

**Title of Invention:**

**METHOD FOR REMOVING NITRIDE MATERIAL**

As the below named inventor, I hereby declare that:  
This declaration is directed to:

☒ The attached application, or

☐ United States application number \_\_\_\_\_ filed on \_\_\_\_\_, or

☐ PCT international application number \_\_\_\_\_ filed on \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the payment by **UNITED MICROELECTRONICS CORP.** having a postal address of \_\_\_\_\_

**No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.**

(referred to as "ASSIGNEE" below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal this FEB 25 2013 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Chi-Sheng Chen**

Date: **FEB 25 2013**

Signature:

*Chi sheng Chen*

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
DSC0-101U016126

**PATENT**

**REEL: 029919 FRAME: 0391**

**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Shin-Chi Chen**

Date: **FEB 25 2013**

Signature:

*Shin-Chi Chen*

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
DSC0-101U016126

PATENT

REEL: 029919 FRAME: 0393

**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Chih-Yueh Li

Date: FEB 25 2013

Signature: Chih-Yueh Li

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
DSC0-101U016126

PATENT  
REEL: 029919 FRAME: 0395



**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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IN WITNESS WHEREOF, I have hereunto set hand and seal this NOV 26 2012 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Ted Ming-Lang Guo

Date: 2012, 11 / 26

Signature: Ted Ming-Lang Guo

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
DSC0-101U016126

PATENT  
REEL: 029919 FRAME: 0397

**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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47  
Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Bo-Syuan Lee**

Date: 2012/11/26

Signature: Bo-Syuan Lee

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CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
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PATENT  
REEL: 029919 FRAME: 0399

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Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Tsung-Hsun Tsai**

Date: **FEB 25 2013**

Signature: *Tsung-Hsun Tsai*

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

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F#NPO-P0002E-US1201  
DSC0-101U016126

**PATENT**  
**REEL: 029919 FRAME: 0401**

**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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IN WITNESS WHEREOF, I have hereunto set hand and seal this DEC 27 2012 (Date of signing)

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Docket No NAUP1570USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Yu-Chin Cheng**

Date:

2012.12.27

Signature:

Yu-Chin Cheng.

NPO#NAU-P1570-USA:0  
CUST#UMCD-2012-0157

Page 14 of 14

F#NPO-P0002E-US1201  
DSC0-101U016126

PATENT

RECORDED: 03/05/2013

REEL: 029919 FRAME: 0403